

## **Initial Information Data Sheet**

### **Inventor Information**

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### **Correspondence Information**

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**Application Information**

Title Line One::  
Title Line Two::  
Total Drawing Sheets::  
Formal Drawings?::  
Application Type::  
Docket Number::

METHODS FOR FILLING HIGH ASPECT RATIO  
TRENCHES IN SEMICONDUCTOR LAYERS  
4  
Yes  
Utility  
MIO 0109 PA/02-1541

**Representative Information**

Registration Number One:: 26,397  
Registration Number Two:: 27,262  
Registration Number Three:: 29,001  
Registration Number Four:: 39,564  
Registration Number Five:: 38,769  
Registration Number Six:: 33,758  
Registration Number Seven:: 42,695  
Registration Number Eight:: 46,867  
Registration Number Nine:: 46,506  
Registration Number Ten:: 46,458  
Registration Number Eleven:: 52,364  
Registration Number Twelve:: 30,871  
Registration Number Thirteen:: 38,086